BENGALURU SMART INFRASTRUCTURE LIMITED (B-SMILE)

Office of the Project Engineer – 01, No. 30/1, 3rd Floor, Thimmaiah Road, Miller Tank Bund Area, Vasanth Nagar, Bengaluru – 560 052

No: B-SMILE/PE-01/TEND/04/2026-27 **Date: 02.07.2026**

CORRIGENDUM – 2

Ref: -

1. Tender Notification No: B-SMILE/PE-01/TEND/04/2026-27 Dated: 20.05.2026
2. Addendum No. 1, Dated: 18-06-2026
3. Corrigendum No. 1, Dated: 18-06-2026
4. Addendum No. 2, Dated: 01-07-2026

With reference to the above-mentioned Tender Notification for the work of **"Construction of Elevated Corridor from Old Madras Road to Electronic City Flyover via Swami Vivekananda Metro Station – Indiranagar – Old Airport Road – Hosur Road – Silk Board Junction (Length 5.20 kms) in Bengaluru City under EPC Mode (UHPFRC-based structures including Maintenance for a period of 10 years)"**, and in exercise of the powers under Clause 9 of the Instructions to Tenderers (ITT), the following Corrigendum is hereby issued to expand the acceptable instruments for submission of the Earnest Money Deposit (EMD) and to further extend the Bid Due Date. All other terms and conditions of the Tender Documents remain unchanged unless specifically modified herein. This Corrigendum is notified through the KPP Portal only.

This Addendum is notified through the KPP Portal only.

Item No.	Existing Provision (RFP / Addendum No. 1)	Revised Provision
1	**Section 2 – ITT, Clause 13 – Earnest Money Deposit (EMD)** Tenderer shall submit EMD of Rs. 8,52,00,000/- (Rs. 1.00 lakh through E-Payment & rest as Surety Bonds/E-BG issued by any of the nationalized / scheduled Bank of India mentioning first party as Bank Second part as Bidder addressing to Tender Inviting Authority or Managing Director, B-SMILE in the prescribed format mentioning the validity of tender as per tender clause and upload in KPPP portal. The original hard copy of Bank Guarantee and letter of credit line certificate must be submitted in Original to the office for verification and further processing.	Tenderer shall submit EMD of Rs. 8,52,00,000/- (Rs. 1.00 lakh through E-Payment & rest as Surety Bonds / E-BG / Physical Bank Guarantee issued by any of the nationalised / scheduled Bank of India, or an Insurance Surety Bond (ISB) issued by an IRDAI-registered insurance company) mentioning first party as Bank / Insurance Company, second party as Bidder, addressing to the Tender Inviting Authority or Managing Director, B-SMILE, in the prescribed format mentioning the validity of tender as per tender clause, and upload a scanned copy in the KPP Portal. The original hard copy of the Bank Guarantee / Physical Bank Guarantee / Insurance Surety Bond and letter of credit line certificate must be submitted in original to the office for verification and further processing.

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Item No.	Existing Provision (RFP / Addendum No. 1)	Revised Provision
2	**NIT – Calendar of Events (Clause 16 of ITT – Deadline for Submission of Tenders)** **Sl. No. 4 – Last Date & Time for Receipt of Tenders:** 03.07.2026 at 16:00 Hours **Sl. No. 5 – Date & Time for Opening of Technical Bid:** 04.07.2026 at 16:30 Hours	The Bid Due Date is hereby further extended as under: **Sl. No. 4 – Last Date & Time for Receipt of Tenders:** 14.07.2026 at 16:00 Hours **Sl. No. 5 – Date & Time for Opening of Technical Bid:** 15.07.2026 at 16:30 Hours All other events in the Calendar of Events remain unchanged. The Validity of Bids shall be reckoned as 180 days from the revised Last Date for Receipt of Tenders, i.e., from 14.07.2026.

All other Terms and Conditions of the Tender Documents remain unchanged.

Sd/-
Project Engineer – 01
Bengaluru Smart Infrastructure Limited (B-SMILE)

Copy Submitted to the:
1. PS to Hon'ble Managing Director to bring into the kind notice of Hon'ble Managing Director, B- SMILE.
2. Director (Technical), B-SMILE for kind information.
3. Office Copy.

02/07/2026
Project Engineer – 01
Bengaluru Smart Infrastructure Limited
(B-SMILE)

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